

## 200V 70A N-Channel Enhancement Mode Power MOSFET

### Description

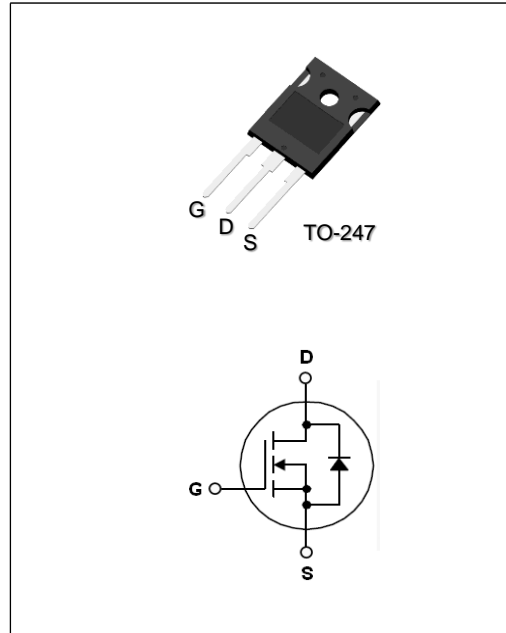
The AKQH70N20 is an N-Channel enhancement mode power MOSFET which using proprietary planar stripe and DMOS technology, it has extremely low static on-resistance and high avalanche energy strength. This device provide excellent switching performance for switched mode power supplies.

### Features

- Advanced Trench Technology
- Typical on-Resistance:  
 $R_{DS(on)}=31m\Omega$  @ $V_{GS}=10V$ ,  $I_D=70A$
- Rated Avalanche Energy
- RoHS Compliant

### Applications

- Switched Mode Power Supplies
- Motor Control
- Synchronous Rectification



### Absolute Maximum Ratings @ $T_C=25^\circ C$ unless otherwise noted

Symbol	Parameter	Ratings	Unit
$V_{DSS}$	Drain to Source Voltage	200	V
$V_{GSS}$	Gate to Source Voltage	$\pm 25$	V
$I_D$	Drain Current	$T_C=25^\circ C$	70
		$T_C=100^\circ C$	45
$I_{DM}$	Pulsed Drain Current (Note1)	280	A
$P_D$	Maximum Power Dissipation	$T_C=25^\circ C$	417
	Derate above $25^\circ C$		3.3
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	3400	mJ
$T_J$	Operating Junction Temperature Range	-55~+150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-55~+150	$^\circ C$

### Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$	Thermal Resistance, Junction to case	0.3	$^\circ C/W$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	40	$^\circ C/W$

## Electrical Characteristics @ $T_c=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	200	-	-	V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3.4	4	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=35A$	-	31	-	m $\Omega$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=V_{DSS}, V_{GS}=0V$	-	-	1	$\mu A$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS}=V_{GSS}, V_{DS}=0V$	-	-	$\pm 100$	nA

## D-S Diode Characteristics and Maximum Rating @ $T_c=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Maximum Drain to Source Diode Forward Current		-	-	70	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS}=0V, I_S=70A$	-	1.0	1.2	V
$t_{rr}$	Reverse Recovery Time	$V_{GS}=0V, I_S=70A,$	-	170	-	ns
$Q_{rr}$	Reverse Recovery Charge	$di/dt=-100A/\mu s$	-	4000	-	nC

## Switching Characteristics @ $T_c=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$I_D=70A,$ $V_{DD}=100V, V_{GS}=10V$ $R_G=25\Omega$ (Note 3)	-	70	-	ns
$t_r$	Rise Time		-	230	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	65	-	ns
$t_f$	Fall Time		-	34	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V, V_{DS}=25V,$ $f=1.0MHz$	-	3000	3870	pF
$C_{oss}$	Output Capacitance		-	720	960	pF
$C_{riss}$	Reverse Transfer Capacitance		-	84	125	pF
$Q_g$	Total Gate Charge	$I_D=70A,$ $V_{DS}=160V$ $V_{GS}=10V$ (Note 3)	-	65	-	nC
$Q_{gs}$	Gate to Source Charge		-	17	-	nC
$Q_{gd}$	Gate to Drain Charge		-	25	-	nC

### Note:

1. Repetitive rating; pulse-width limited by maximum junction temperature
2.  $V_{DD}=100V, L=2mH, V_G=10V, I_{AS}=70A$
3. Essentially independent of operating temperature typical characteristics

**Typical Performance Characteristics**

Fig. 1. Typical on-Resistance Characteristics

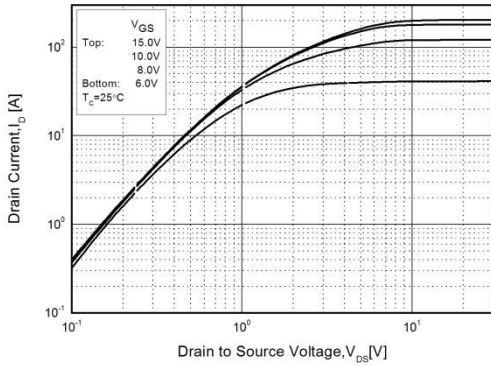


Fig. 2. Typical Transfer Characteristics

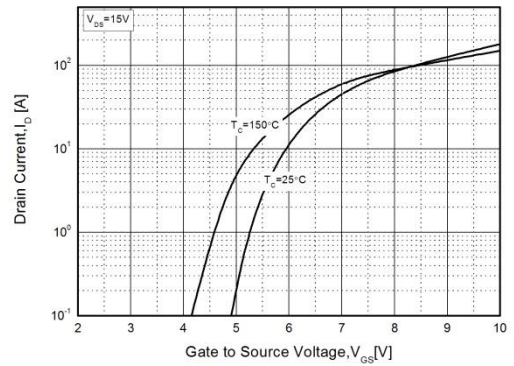


Fig. 3. Static on-Resistance vs.  $I_D$

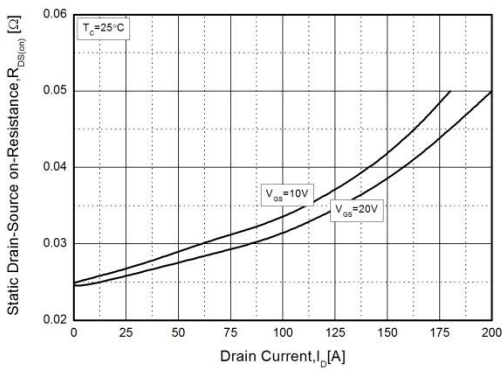


Fig. 4. Body Diode Forward Voltage vs.  $I_{DR}$

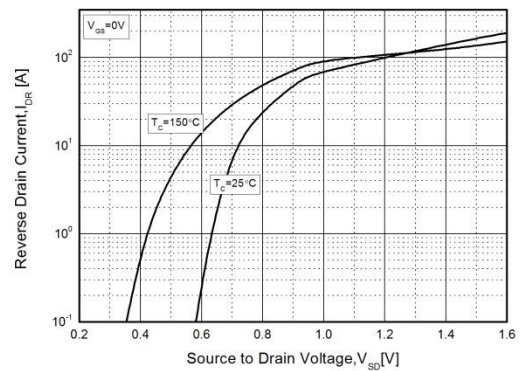


Fig. 5. Capacitance Characteristics

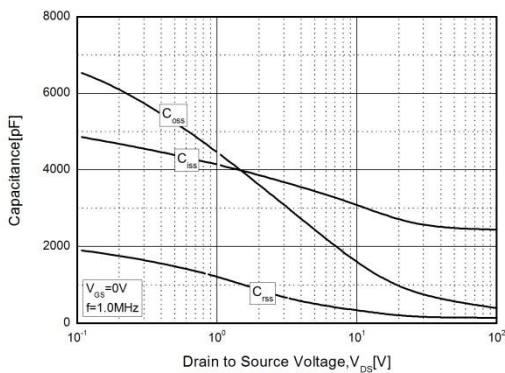
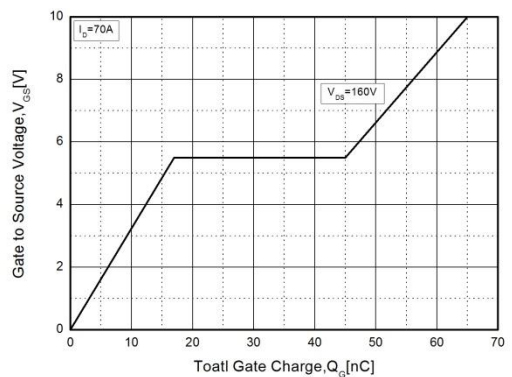


Fig. 6. Gate Charge Characteristics



**Typical Performance Characteristics**

Fig. 7. Breakdown Voltage vs. Temperature

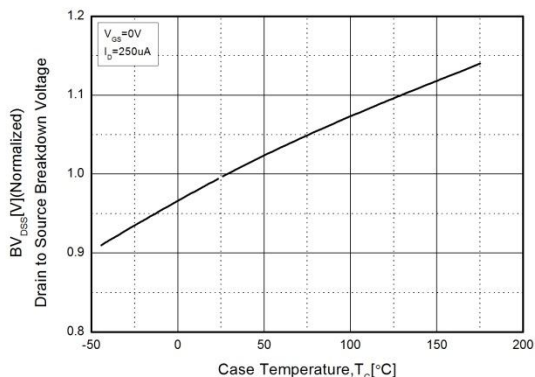


Fig. 8. Static on-Resistance vs. Temperature

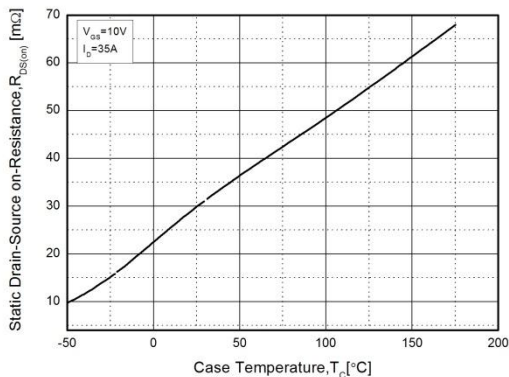


Fig. 9. Maximum Safe Operating Area

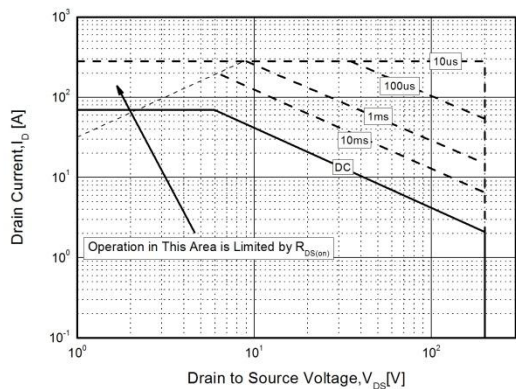


Fig. 10. Maximum Drain Current vs. Temperature

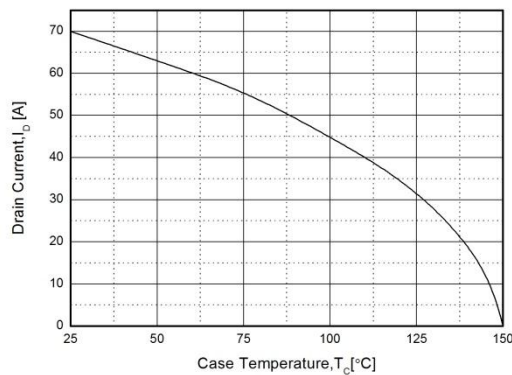
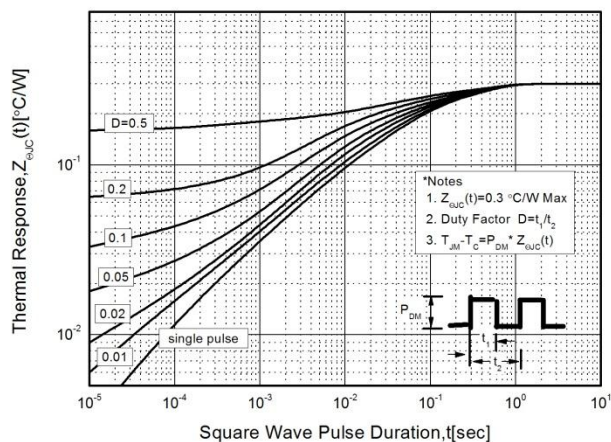


Fig. 11. Transient Thermal Response Curve



**Package Dimensions**

**TO-247**

(Dimensions in Millimeters)

